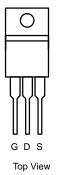


SUP85N02-03-E3-VB Datasheet N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A) ^a		
20	$0.004@V_{GS} = 4.5V$	100		
	0.005@ V _{GS} = 2.5 V	95		



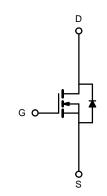


FEATURES

- Trench Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2011/65/EU

APPLICATIONS

- OR-ing
- Server
- DC/DC



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25°C UNLESS OTHERWISE NOTED)						
Paramete	er	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	20	V		
Gate-Source Voltage		V _{GS}	±12			
Continuous Drain Current (T ₁ = 175° C)	T _C = 25°C	I_	100			
Continuous Drain Current (1) = 175 C)	T _C = 100°C	ч ^р	85	А		
Pulsed Drain Current		I _{DM}	260	A		
Avalanche Current		I _{AR}	35			
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	45	mJ		
Power Dissipation	T _C = 25°C	PD	125 ^a	W		
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	-55 to 175	°C		

THERMAL RESISTANCE RAT	INGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^c	P	40	
Junction-to-Ambient	Free Air (TO-220AB)	R _{thJA}	62.5	°C/W
Junction-to-Case		R _{thJC}	1.25	

Notes:

a. See SOA curve for voltage derating.

b. Duty cycle \leq 1%. c. When mounted on 1" square PCB (FR-4 material).



COMPLIANT

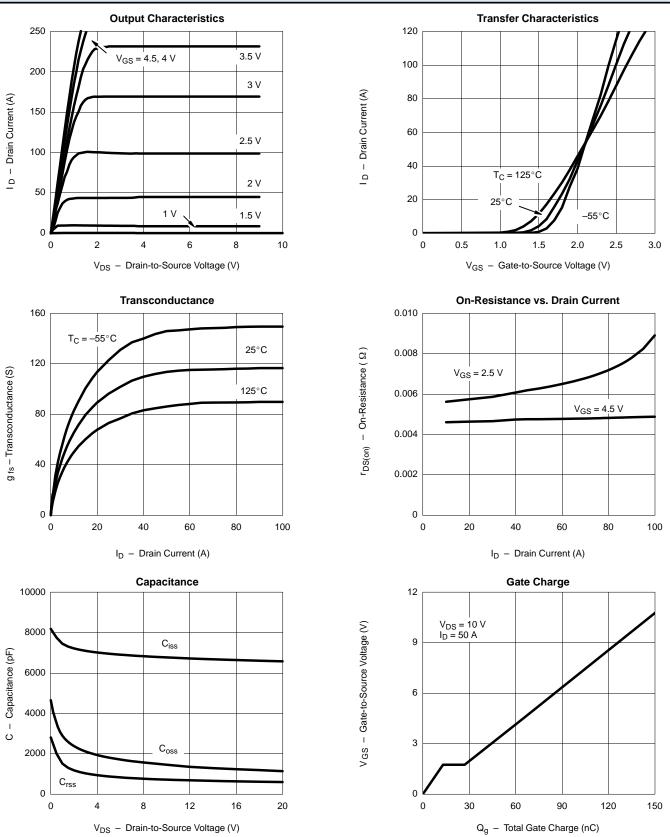
SUP85N02-03-E3-VB



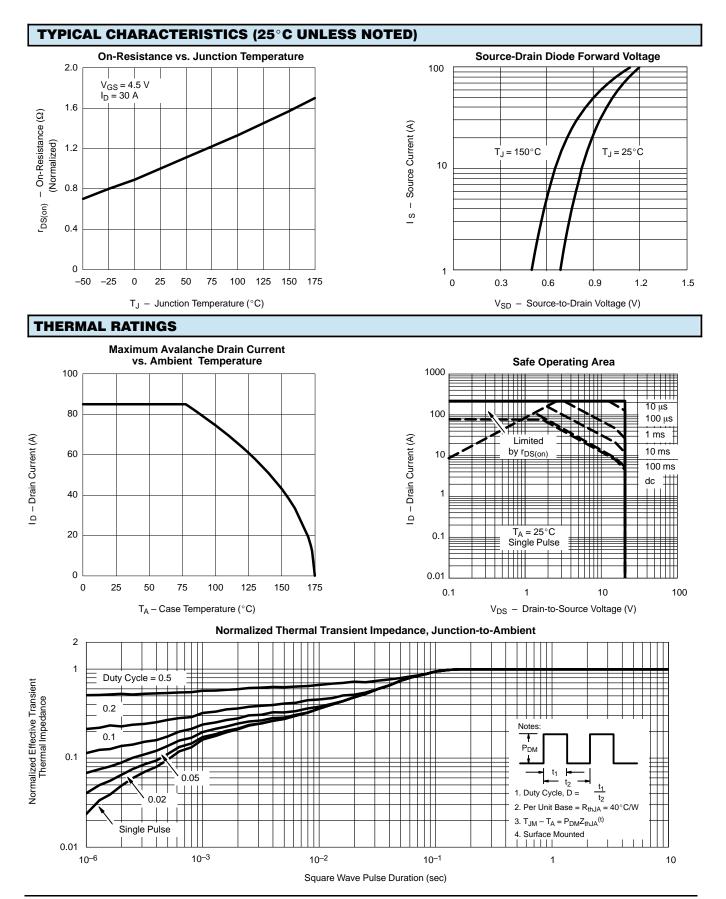
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA	20			<u> </u>	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{DS} = 250 \ \mu A$	0.5		1.5	V	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±12 V			±100	nA	
		V _{DS} = 20 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125^{\circ}\text{C}$			50	μΑ	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175^{\circ}\text{C}$			150	1	
On-State Drain Current ^a	I _{D(on)}	V_{DS} = 5 V, V_{GS} = 4.5 V	120			A	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$	0.004				
		$V_{GS} = 4.5 \text{ V}, I_{D} = 30 \text{ A}, T_{J} = 125^{\circ}\text{C}$					
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_{D} = 30 \text{ A}, T_{J} = 175^{\circ}\text{C}$		0.010		Ω	
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.005		1	
Forward Transconductancea	9 _{fs}	$V_{DS} = 5 V, I_D = 30 A$	20			S	
Dynamic ^b	- I - I		•		•		
Input Capacitance	C _{iss}			6000			
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz		1100		pF	
Reversen Transfer Capacitance	C _{rss}			600		1	
Total Gate Charge ^c	Qg			65	130	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 85 A		13			
Gate-Drain Charge ^c	Q _{gd}			14			
Turn-On Delay Time ^c	t _{d(on)}			25	40	ns	
Rise Time ^c	tr	V_{DD} = 10 V, R _L = 0.12 Ω		120	180		
Turn-Off Delay Time ^c	t _{d(off)}	${\sf I}_{\sf D}\simeq$ 85 A, ${\sf V}_{\sf GEN}$ = 4.5 V, ${\sf R}_{\sf G}$ = 2.5 Ω		80	120		
Fall Time ^c	t _f			100	150		
Source-Drain Diode Ratings a	nd Characteristic	cs (T _C = 25°C) ^b		-			
Pulsed Current	I _{SM}				240	A	
Forward Voltage ^a	V _{SD}	I _F = 100 A, V _{GS} = 0 V		1.2	1.5	V	
Reverse Recovery Time	t _{rr}	I _F = 50 A, di/dt = 100 A/μs		45	100	ns	



TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

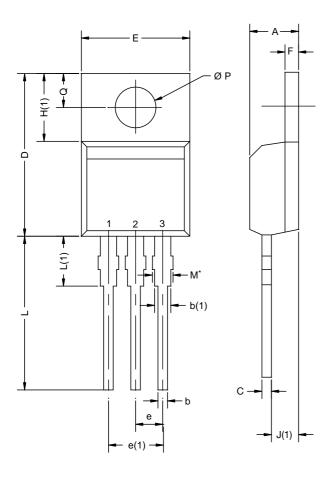








TO-220AB



	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12- DWG: 547	-0208-Rev. N, ′1	08-Oct-12			

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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